

R1282D002A SERIES

2CH PWM DC/DC CONTROLLER

NO.EA-086-160126

OUTLINE

The R1282D002A is a CMOS-based 2-channel PWM Step-up (as Channel 1)/Step-down (as Channel 2) DC/DC converter controller.

The R1282D002A consists of an oscillator, a PWM control circuit, a reference voltage unit, an error amplifier, a reference current unit, a protection circuit, and an under voltage lockout (UVLO) circuit. A high efficiency Step-up/Step-down DC/DC converter can be composed of this IC with inductors, diodes, power MOSFETs, resisters, and capacitors. Each output voltage and maximum duty cycle can be adjustable with external resistors, while soft-start time can be adjustable with external capacitors and resistors.

As for a protection circuit, if Maximum duty cycle of either Step-up DC/DC converter side or Step-down DC/DC converter side is continued for a certain time, the R1280D002A latches both external drivers with their off state by its Latch-type protection circuit. Delay time for protection is internally fixed typically at 100ms. To release the protection circuit, restart with power-on (Voltage supplier is equal or less than UVLO detector threshold level).

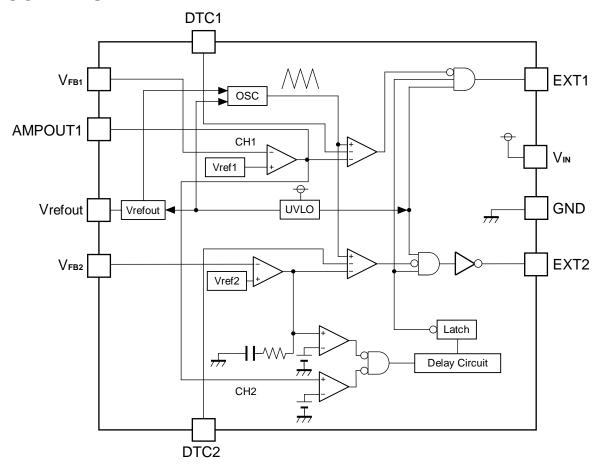
FEATURES

Input Voltage Range	2.5V to 5.5V
Built-in Latch-type Protection Function by more	nitoring duty cycle (Fixed Delay Time Typ. 100ms)
Oscillator Frequency	700kHz
High Accuracy Voltage Reference	±1.5%
U.V.L.O. Threshold	Typ. 2.2V (Hysteresis: Typ. 0.2V)
Small Package	thin SON-10 (package thickness Max. 0.9mm)

APPLICATIONS

- Constant Voltage Power Source for Portable Equipment.
- Constant Voltage Power Source for LCD and CCD.

BLOCK DIAGRAM



SELECTION GUIDE

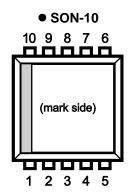
The selection can be made with designating the part number as shown below;

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
R1282D002x-TR-FE	SON-10	3,000 pcs	Yes	Yes

x: Designation of Mask Option

A version: fosc=700kHz, with External Phase Compensation for Channel 1

PIN CONFIGURATION



PIN DESCRIPTION

Pin No	Symbol	Description	
1	EXT1	External Transistor of Channel 1 Drive Pin (CMOS Output)	
2	GND	Ground Pin	
3	AMPOUT1	Amplifier Output Pin of Channel 1	
4	DTC1	Maximum Duty Cycle of Channel 1 Setting Pin	
5	V _{FB1}	Feedback pin of Channel 1	
6	V _{FB2}	Feedback pin of Channel 2	
7	DTC2	Maximum Duty Cycle of Channel 2 Setting Pin	
8	Vrefout	Reference Output Pin	
9	Vin	Voltage Supply Pin of the IC	
10	EXT2	External Transistor of Channel 2 Drive Pin (CMOS Output)	

ABSOLUTE MAXIMUM RATINGS

Symbol	Item	Rating	Unit
Vin	V _{IN} Pin Voltage	6.5	V
VEXT1,2	V _{EXT1,2} Pin Output Voltage	-0.3~V _{IN} +0.3	V
V _{AMPOUT1}	AMPOUT1 Pin Voltage	-0.3~V _{IN} +0.3	V
V _{DTC1,2}	DTC1,2 Pin Voltage	-0.3~V _{IN} +0.3	V
Vrefout	VREFOUT Pin Voltage	-0.3~Vin+0.3	V
V _{FB1,2}	V _{FB1} ,V _{FB2} Pin Voltage	-0.3~V _{IN} +0.3	V
IEXT1,2	EXT1,2 Pin Output Current	±50	mA
P _D	Power Dissipation	250	mW
Topt	Operating Temperature Range	-40 to +85	°C
Tstg	Storage Temperature Range	-55 to +125	°C

ELECTRICAL CHARACTERISTICS

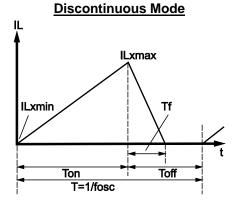
Topt=25°C

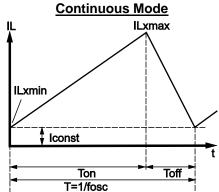
Symbol	Item	Conditions	Min.	Тур.	Max.	Unit
Vin	Operating Input Voltage		2.5		5.5	V
VREFOUT	VREFOUT Voltage Tolerance	VIN=3.3V, IOUT=1mA	1.478	1.500	1.522	V
I ROUT	VREFOUT Output Current	V _{IN} =3.3V				mA
$\Delta V_{REFOUT}/\Delta V_{IN}$	VREFOUT Line Regulation	$2.5V \le V_{IN} \le 5.5V$		2	6	mV
$\Delta V_{REFOUT} / \Delta I_{OUT}$	VREFOUT Load Regulation	$1\text{mA} \leq I_{\text{ROUT}} \leq 10\text{mA V}_{\text{IN}}=3.3\text{V}$		6	12	mV
Іім	VREFOUT Short Current Limit	VIN=3.3V, VREFOUT=0V		25		mA
ΔV refout/ ΔT	VREFOUT Voltage Temperature Coefficient	$-40^{\circ}\text{C} \leq \text{Topt} \leq 85^{\circ}\text{C}$		±150		ppm/°C
V _{FB1}	V _{FB1} Voltage	V _{IN} =3.3V	0.985	1.000	1.015	V
$\Delta V_{\text{FB1}}/\Delta T$	V _{FB1} Voltage Temperature Coefficient	$-40^{\circ}\text{C} \leq \text{Topt} \leq 85^{\circ}\text{C}$		±150		ppm/°C
$\Delta V_{FB2}/\Delta T$	V _{FB2} Voltage Temperature Coefficient	-40°C ≤ Topt ≤ 85°C		±150		ppm/°C
IVFB1,2	V _{FB1,2} Input Current	VIN=5.5V,VFB1 or VFB2=0V or 5.5V	-0.1		0.1	μΑ
fosc	Oscillator Frequency	EXT1,2 Pins at no load, V _{IN} =3.3V	595	700	805	kHz
I _{DD1}	Supply Current	V _{IN} =5.5V, EXT1,2 pins at no load		1.4	3.0	mA
R _{EXTH1}	EXT1 "H" ON Resistance	VIN=3.3V, IEXT=-20mA		4.0	8.0	Ω
REXTL1	EXT1 "L" ON Resistance	VIN=3.3V, IEXT=20mA		2.7	5.0	Ω
REXTH2	EXT2 "H" ON Resistance	VIN=3.3V, IEXT=-20mA		4.0	8.0	Ω
REXTL2	EXT2 "L" ON Resistance	VIN=3.3V, IEXT=20mA		3.7	8.0	Ω
TDLY	Delay Time for Protection	V _{IN} =3.3V, V _{FB1} =1.1V→0V	60	100	140	ms
Vuvlod	UVLO Detector Threshold		2.10	2.20	2.35	V
Vuvlo	UVLO Released Voltage			Vuvlod +0.20	2.48	٧
V _{DTC10}	CH1 Duty=0%	V _{IN} =3.3V	0.1	0.2	0.3	V
V _{DTC1100}	CH1 Duty=100%	V _{IN} =3.3V	1.1	1.2	1.3	V
V _{DTC20}	CH2 Duty=0%	V _{IN} =3.3V	0.1	0.2	0.3	V
V _{DTC2100}	CH2 Duty=100%	V _{IN} =3.3V	1.1	1.2	1.3	V
A _{V1}	CH1 Open Loop Gain	V _{IN} =3.3V		110		dB
F _{T1}	CH1 Single Gain Frequency Band	VIN=3.3V, Av1=0dB		1.9		MHz
V _{ICR1}	CH1 Input Voltage Range	VIN=3.3V		0.7 to V _{IN}		V
IAMPL	CH1 Sink Current	VIN=3.3V, VAMPOUT1=1.0V,VFB1=VFB1+ 0.1V	70	115		μΑ
I _{АМРН}	CH1 Source Current	VIN=3.3V, VAMPOUT1=1.0V,VFB1=VFB1- 0.1V		-1.4	-0.7	mA
A _{V2}	CH2 Open Loop Gain	V _{IN} =3.3V		60		dB
F _{T2}	CH2 Single Gain Frequency Band	V _{IN} =3.3V, A _{V2} =0dB		600		kHz
V _{ICR2}	CH2 Input Voltage Range	V _{IN} =3.3V		-0.2 to V _{IN} -1.3		٧
V _{FB2}	CH2 Reference Voltage	V _{IN} =3.3V	0.985	1.000	1.015	V

Output Current and Selection of External Components

VIN Diode Vout Inductor Diode Vout Vout CLX Tr CL

<Current through L>





There are two modes, or discontinuous mode and continuous mode for the PWM step-up switching regulator depending on the continuous characteristic of inductor current.

During on time of the transistor, when the voltage added on to the inductor is described as V_{IN} , the current is $V_{IN} \times t/L$.

Therefore, the electric power, Pon, which is supplied with input side, can be described as in next formula.

$$P_{ON} = \int_{0}^{T_{ON}} V_{IN}^{2} \times t/L \ dt \dots Formula 1$$

With the step-up circuit, electric power is supplied from power source also during off time. In this case, input current is described as (Vout-Vin)×t/L, therefore electric power, Poff is described as in next formula.

$$P_{\text{OFF}} = \int_{0}^{Tf} V_{\text{IN}} \times (V_{\text{OUT}} - V_{\text{IN}}) t/L \ dt \ ...$$
 Formula 2

In this formula, Tf means the time of which the energy saved in the inductance is being emitted. Thus average electric power, P_{AV} is described as in the next formula.

$$P_{AV} = 1/(Ton + Toff) \times \{ \int_0^{Ton} V_{IN}^2 \times t/L \ dt + \int_0^{Tf} V_{IN} \times (V_{OUT} - V_{IN})t/L \ dt \} \$$
 Formula 3

In PWM control, when Tf=Toff is true, the inductor current becomes continuos, then the operation of switching regulator becomes continuous mode.

In the continuous mode, the deviation of the current is equal between on time and off time.

Vin×Ton/L=(Vout-Vin)×Toff/LFormula 4

Further, the electric power, Pav is equal to output electric power, Voutxlout, thus,

$$lout = fosc \times Vin^2 \times Ton^2 / \{2 \times L \times (Vout - Vin)\} = Vin^2 \times Ton / (2 \times L \times Vout) ... Formula 5$$

When I_{OUT} becomes more than $V_{IN} \times Ton \times Toff/(2 \times L \times (Ton + Toff))$, the current flows through the inductor, then the mode becomes continuous. The continuous current through the inductor is described as Iconst, then,

$$I_{OUT} = f_{OSC} \times V_{IN}^2 \times Ton^2/(2 \times L \times (V_{OUT} - V_{IN})) + V_{IN} \times I_{CONST}/V_{OUT}$$
 Formula 6

In this moment, the peak current, ILXmax flowing through the inductor and the driver Tr. is described as follows:

$$IL \times max = Iconst + V_{IN} \times Ton/L$$
 Formula 7

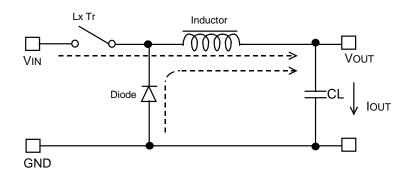
With the formula 4,6, and ILxmax is,

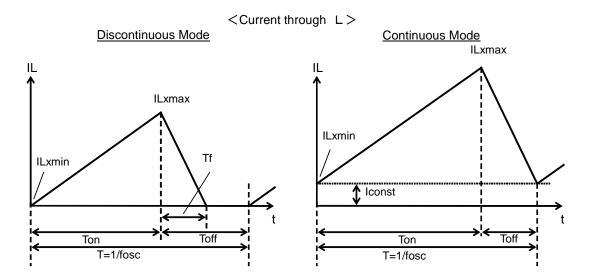
Therefore, peak current is more than IouT. Considering the value of ILxmax the condition of input and output, and external components should be selected.

In the formula 7, peak current ILxmax at discontinuous mode can be calculated. Put Iconst=0 in the formula.

The explanation above is based on the ideal calculation, and the loss caused by Lx switch and external components is not included. The actual maximum output current is between 50% and 80% of the calculation. Especially, when the ILx is large, or V_{IN} is low, the loss of V_{IN} is generated with the on resistance of the switch. As for V_{OUT} , Vf (as much as 0.3V) of the diode should be considered.

There are also two modes, or discontinuous mode and continuous mode for the PWM step-down switching regulator depending on the continuous characteristic of inductor current.





During on time of the transistor, when the voltage added on to the inductor is described as $V_{IN}-V_{OUT}$ the current is $(V_{IN}-V_{OUT}) \times t/L$.

Therefore, the electric power, P, which is supplied from the input side, can be described as in next formula.

$$P = \int_{0}^{Ton} V_{IN} \cdot (V_{IN} - V_{OUT}) \cdot t / L dt ...$$
 Formula 9

Thus average electric power in one cycle, P_{AV} is described as in the next formula.

$$P_{\text{AV}} = 1/(\text{Ton+Toff}) \quad \int_0^{\text{Ton}} V_{\text{IN}} \cdot (V_{\text{IN}} - V_{\text{OUT}}) \cdot t / L \ dt = V_{\text{IN}} \cdot (V_{\text{IN}} - V_{\text{OUT}}) \cdot \text{Ton}^2 / \left(2 \cdot L \ (\text{Ton+Toff})\right) \dots \text{Formula } 10$$

This electric power Pav equals to output electric power Vout × Iout, thus,

When lout increases and the current flows through the inductor continuously, then the mode becomes continuous. In the continuous mode, the deviation of the current equals between Ton and Toff, therefore,

In this moment, the current flowing continuously through L, is assumed as Iconst, IouT is described as in the next formula:

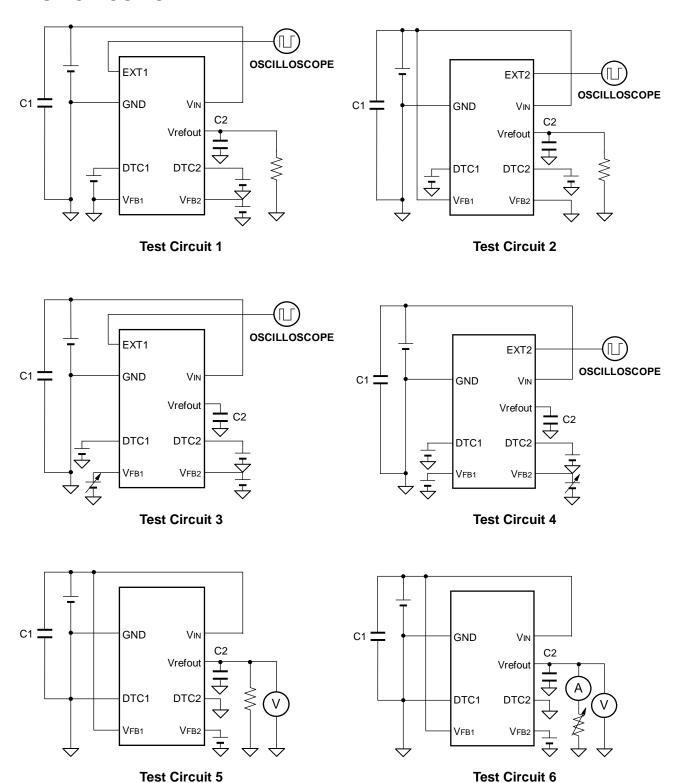
Iout=Iconst+Vout×Toff /(2×L)	Formula 13
In this moment, the peak current, ILxmax flowing through the inductor and the dri	iver Tr. is described as follows:
ILxmax= Iоит +Vоит×Toff/(2×L)	Formula 14
With the formula 12,13, ILxmax is,	
Toff=(1-Vout/Vin)/fosc	Formula 15

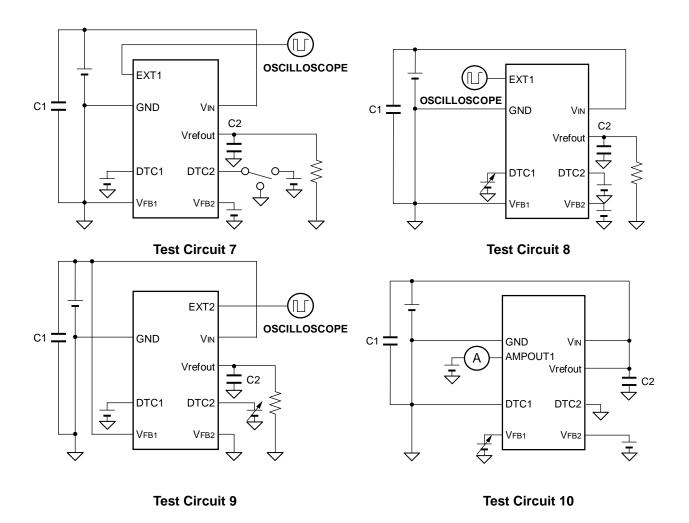
Therefore, peak current is more than IouT. Considering the value of ILxmax, the condition of input and output, and external components should be selected.

In the formula 14, peak current ILxmax at discontinuous mode can be calculated. Put Iconst=0 in the formula.

The explanation above is based on the ideal calculation, and the loss caused by Lx switch and external components is not included.

TEST CIRCUITS





Typical Characteristics shown in the following pages are obtained with test circuits shown above.

Test Circuit 1,2: Typical Characteristic 4) Test Circuit 3: Typical Characteristic 5) Test Circuit 4: Typical Characteristic 5) Test Circuit 5: Typical Characteristic 6) Test Circuit 6: Typical Characteristics 7) 8) Test Circuit 7: Typical Characteristic 9) Test Circuit 8: Typical Characteristic 10) Test Circuit 9: Typical Characteristics 10) Test Circuit 10: Typical Characteristics 11) 12)

Note) Capacitors' values of test circuits

Capacitors: Ceramic Type:

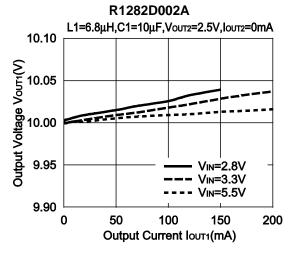
 $C1=4.7\mu F$, $C2=1.0\mu F$

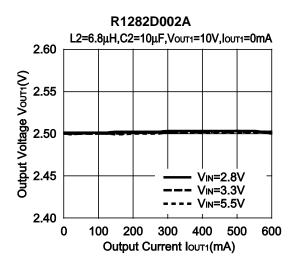
Efficiency $\eta(\%)$ can be calculated with the next formula:

 $\eta = (V_{\text{OUT1}} \times I_{\text{OUT1}} + V_{\text{OUT2}} \times I_{\text{OUT2}}) / (V_{\text{IN}} \times I_{\text{IN}}) \times 100$

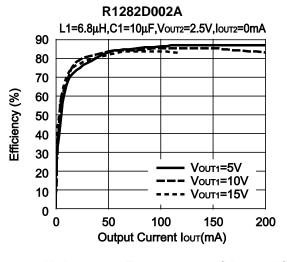
TYPICAL CHARACTERISTICS

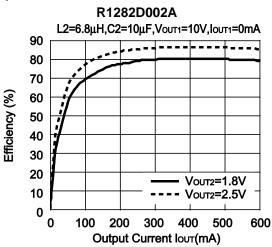
1) Output Voltage vs. Output Current (Topt=25°C)



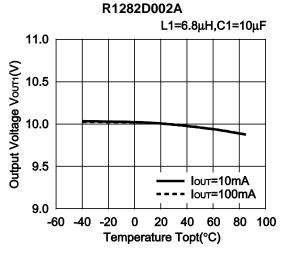


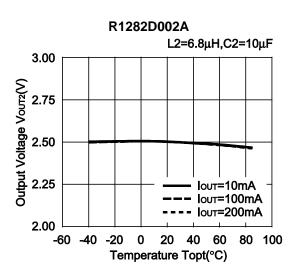
2) Efficiency vs. Output Current (Vin=3.3V, Topt=25°C)



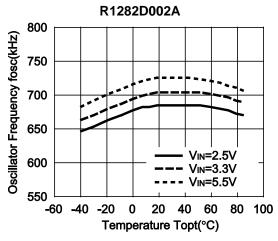


3) Output Voltage vs. Temperature (Vin=3.3V)

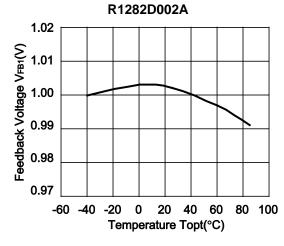


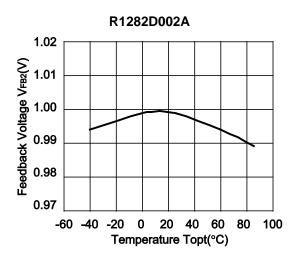


4) Frequency vs. Temperature

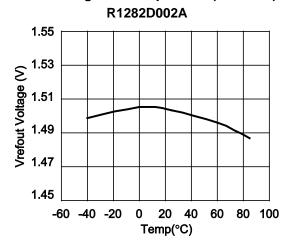


5) Feedback Voltage vs. Temperature (VIN=3.3V)

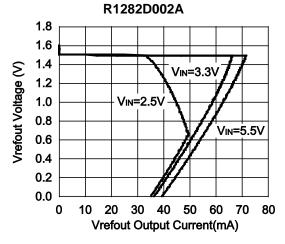




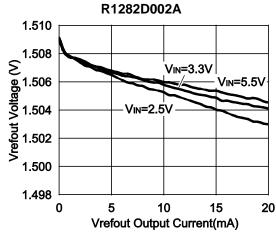
6) Vrefout Voltage vs. Temperature(Vin=3.3V)



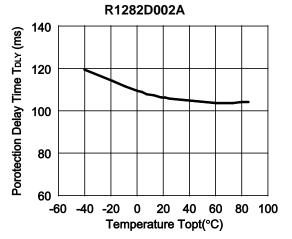
7) Vrefout Output Voltage vs. Output Current



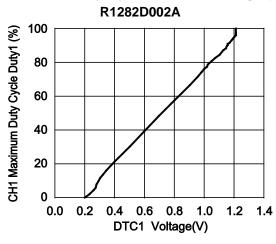
8) Vrefout Output Voltage vs. Output Current

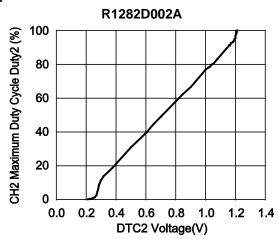


9) Protection Delay Time vs. Temperature (VIN=3.3V)

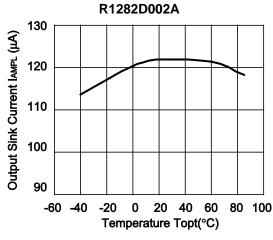


10) Maximum Duty Cycle vs. DTC Voltage (Vin=3.3V)

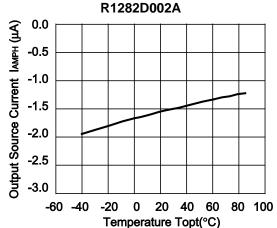




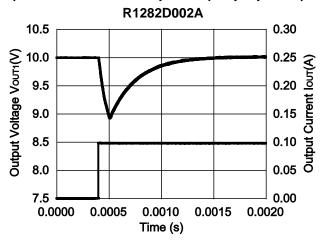
11) Output Sink Current vs. Temperature (VIN=3.3V)

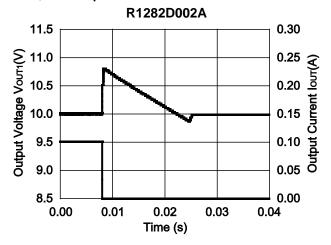


12) Output Source Current vs. Temperature

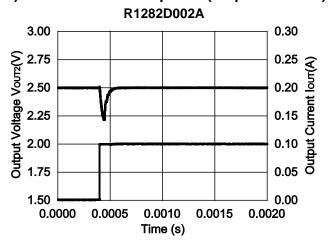


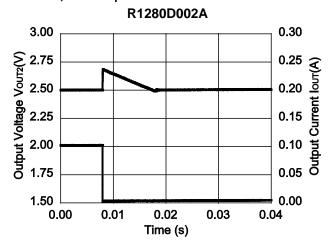
13) Load Transient Response (Step-up Side) VIN=3.3V, L1=6.8μH



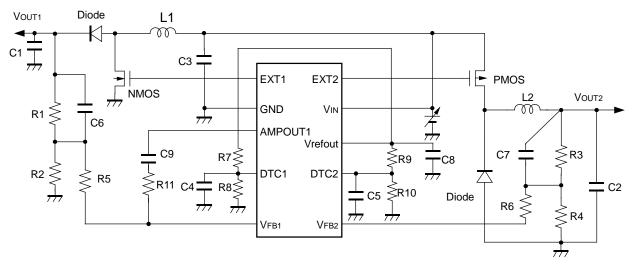


14) Load Transient Response (Step-down Side) VIN=3.3V, L2=6.8μH





TYPICAL APPLICATION AND TECHNICAL NOTES



Components examples

Inductor L1,2 6.8µH VLF504012MT (TDK)

Diode CRS10I30A (Toshiba) PMOS Si3443DV (Siliconix)

NMOS IRF7601 (International Rectifier)

Resistance As setting resistors total value for the output voltage, R1+R2, R3+R4 recommendation value is 100kW or less.

R1=47k Ω R2=5.1k Ω R3=30k Ω R4=20k Ω

R5=43k Ω R6=10kW Ω

 $R7=R9=22k\Omega$ $R8=R10=43k\Omega$ $R11=220k\Omega$

Capacitors Ceramic Type

 $C1=C2=10\mu F$ $C3=4.7\mu F$ $C4=0.22\mu F$ $C5=0.47\mu F$ C6=120p F

C7=50pF $C8=1\mu F$ C9=1000pF

Note) Consider the ratings of external components including voltage tolerance. With the transistor in the circuit above, Vout=15V is the voltage setting limit.

EXTERNAL COMPONENTS

1. How to set the output voltages

As for step-up side, feedback (VFB1) pin voltage is controlled to maintain 1V, therefore,

Vout1: R1+R2=VFB1: R2

Thus, $V_{OUT1}=V_{FB1}\times (R1+R2)/R2$

Output Voltage is adjustable with R1 and R2.

As for Step-down side, Feedback (VFB2) pin voltage follows the next formula,

Vout2: R3+R4=VFB2: R4

Thus, $V_{OUT2}=V_{FB2}\times (R3+R4)/R4$

Output Voltage is adjustable with R3 and R4.

2. How to set Soft-Start Time and Maximum Duty Cycle

Soft-start time is adjustable with connecting resistors and a capacitor to DTC pin.

Soft starting time, Tss1 and Tss2 are adjustable. Soft-start time can be set with the time constant of RC.

Soft-start time can be described as in next formula.

Tss1≅RO1×C4

If R10=0 Ω , then,

 $T_{SS2} = R9 \times C5 \times In((Vrefout-VDTC2)/Vrefout)$

Maximum Duty Cycle is set with the voltage to DTC1 and DTC2.

Maximum duty cycle is described as follows;

CH1 (Step-up side)

Maxduty1≅ (R8/(R7+R8) ×Vrefout-0.2)/(1.2-0.2) ×100 (%)

Step-up side maximum duty cycle should be set equal or less than 90%. If the maximum duty cycle is set at high percentage, operation will be unstable.

TECHNICAL NOTES on EXTERNAL COMPONENTS

- External components should be set as close to this IC as possible. Especially, wiring of the capacitor connected to V_{IN} pin should be as short as possible.
- Enforce the ground wire. Large current caused by switching operation flows through GND pin. If the impedance of ground wire is high, internal voltage level of this IC might fluctuate and operation could be unstable.
- Recommended capacitance value of C3 is equal or more than 4.7μF.
- If the spike noise of V_{OUT1} is too large, the noise is feedback from V_{FB1} pin and operation might be unstable.
 In that case, use the resistor ranging from 10kΩ to 50kΩ as R5 and try to reduce the noise level. In the case of V_{OUT2}, use the resistor as much as 10kΩ as R6.
- Select an inductor with low D.C. current, large permissible current, and uneasy to cause magnetic saturation. If the inductance value is too small, ILx might be beyond the absolute maximum rating at the maximum load.
- Select a Schottky diode with fast switching speed and large enough permissible current.
- Recommended capacitance value of C1 and C2 is as much as Ceramic 10μF. In case that the operation with
 the system of DC/DC converter would be unstable, add a series resister less than 0.5Ω to each output
 capacitor or use tantalum capacitors with appropriate ESR. If you choose too large ESR, ripple noise may
 be forced to V_{FB1} and V_{FB2}, and unstable operation may result. Use a capacitor with fully large voltage
 tolerance of the capacitor.
- this IC, for the test efficiency, latch release function is included. By forcing (V_{IN}-0.3)V or more voltage to DTC1 pin or DTC2 pin, Latch release function works.
- Performance of the power controller with using this IC depends on external components. Each component, layout should not be beyond each absolute maximum rating such as voltage, current, and power dissipation.



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- 7. Anti-radiation design is not implemented in the products described in this document.
- 8. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
- 9. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
- 10. There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used. In the case of recognizing the marking characteristic with AOI, please contact our sales or our distributor before attempting to use AOI.
- 11. Please contact our sales representatives should you have any questions or comments concerning the products or the technical information.



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